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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT			
NATURE OF CONVEYANCE:		ASSIGNMENT			
CONVEYING PARTY D	ΑΤΑ	· ·			
		Name Execu		Execution Date	
MITSUBISHI HEAVY IN	DUSTRIES	S, LTD.		01/05/2016	
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State/Country:	JAPAN	JAPAN			
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PROPERTY NUMBERS	6 Total: 3				
Property Type		Number			
Application Number:		4127828			
Application Number:		4024865			
Application Number:		4494867			
	·				
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ATTORNEY DOCKET NUMBER:		2013-1368A			
NAME OF SUBMITTER:		KELLY FORE			
SIGNATURE:		/KELLY FORE/	/KELLY FORE/		
DATE SIGNED:		01/14/2016			
Total Attachments: 2					
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ASSIGNMENT

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR: Mitsubishi Heavy Industries, Ltd. (hereinafter, designated as the ASSIGNOR) 16-5, Konan 2-chome, Minato-ku, Tokyo, Japan 108-8215

the owner of the entire right, title and interest in and to:

(1) U.S. Patent Application No. 14/127,828, filed December 19, 2013, entitled PROCESSING APPARATUS AND PROCESSING METHOD;

(2) U.S. Patent Application No. 14/024,865, filed September 12, 2013, entitled ACCELERATING STRUCTURE; and

(3) U.S. Patent Application No. 14/494,867, filed September 24, 2014, entitled SUPERCONDUCTING ACCELERATING CAVITY AND ELECTROPOLISHING METHOD FOR SUPERCONDUCTING ACCELERATING CAVITY;

hereby sell(s) and assign(s) to

ASSIGNEE: Mitsubishi Heavy Industries Mechatronics Systems, Ltd. (hereinafter designated the ASSIGNEE) 4-22, Wadamiya-dori 5-chome, Hyogo-ku, Kobe-shi Hyogo 652-0863 Japan

the entire right, title and interest for the United States of America as defined in 35 USC 100, in the inventions found in (1) U.S. Patent Application No. 14/127,828; (2) U.S. Patent Application No. 14/024,865; and (3) U.S. Patent Application No. 14/494,867 and, in and to, all Letters Patent to be obtained for said inventions by any continuation, division, reissue or reexamination of said United States Patents.

The ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

The ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided with all pertinent facts and documents relating to said invention and said application and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any proceeding related thereto, and that ASSIGNOR will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue, and enforce said application, said invention, any Letters Patent resulting from said application, and said equivalents thereof which may be necessary or desirable to carry out the purpose thereof,

The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 1030 15th Street, N.W., Suite 400 East, Washington, D.C. 20005, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordal of this document.

PATENT REEL: 037491 FRAME: 0463 Furthermore, the undersigned has reviewed all the documents in the chain of title of (1) U.S. Patent Application No. 14/127,828; (2) U.S. Patent Application No. 14/024,865; and (3) U.S. Patent Application No. 14/494,867 and, to the best of the undersigned's knowledge and belief, title is in the ASSIGNOR identified above.

IN witness whereof, J/WE have hereunto set hand and seal this <u>5th day of January</u>, 2016 (Date of signing)

HIROMICHI ITO (type or print the name of person who signs above)

<u>General Manager of Intellectual Property Department</u> (Official Title of person who signs above)

Witness

MASAAKI IKEDA

Witness

TOMOKO GABE

PATENT REEL: 037491 FRAME: 0464

RECORDED: 01/14/2016

⁽Signature of person authorized to sign on behalf of ASSIGNOR)